

SSCJ56N650GTF

N-Channel 650V Super Junction Power MOSFET

> Features

V _{DS}	R _{DS(ON)} Typ.	ID
650V	56mΩ@10V	55A

> Description

- Low ON Resistance
- Improved dv/dt Capability
- Intrinsic Fast-Recovery Body Diode
- Fast switching capability
- 100% Avalanche Tested
- RoHS compliant

> Applications

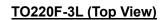
- EV Charger
- Sever/Telecom/PC Power
- AC-DC Power Management
- Solar Inverte

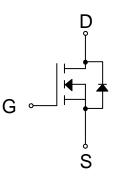
Ordering Information

Device	Package	Shipping
SSCJ56N650GTF	TO220F-3L	50/Tube

> Pin Configuration







Pin Configuration



<u>Marking</u>

(XXYY: Internal Traceability Code)





> Absolute Maximum Ratings ($T_J=25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain-to-Source Voltage	650	V
V _{GSS}	Gate-to-Source Voltage (dynamic)	±30	
ID	Continuous Drain Current TJ=25°C	55	Α
I _{DM}	Pulsed Drain Current	165	Α
dv/dt	MOSFET dv/dt Ruggedness(VDS=0~480V)	50	V/ns
Tstg /Tj	Junction & Storage Temperature Range	-55 to 150	°C

> Thermal Resistance Ratings (T_J=25 $^{\circ}$ C unless otherwise noted)

Symbol	Parameter	Ratings	Unit	
R _{0JA}	Thermal Resistance, Junction to Ambient ^c 66		°C / M	
R _{θJC}	Thermal Resistance, Junction to Case	3.0	°C/W	

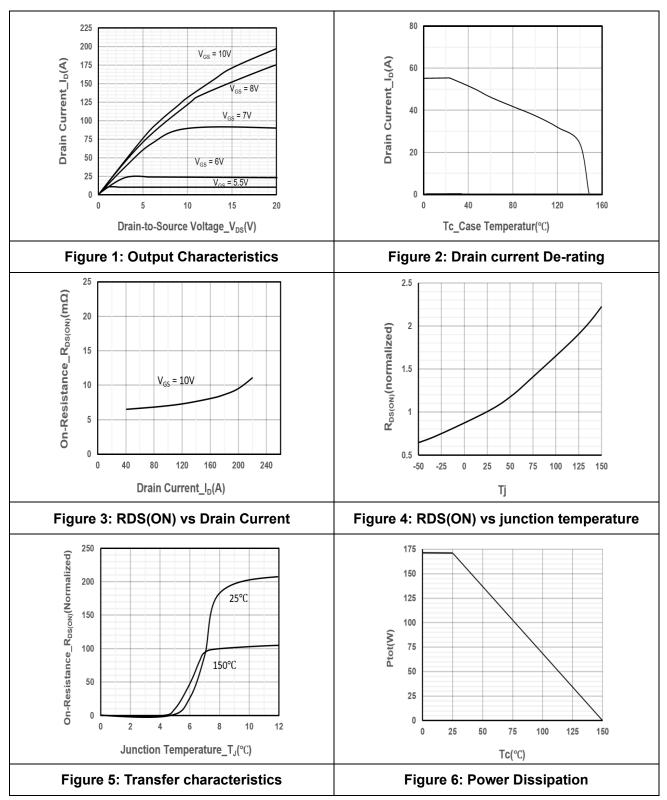


\succ Electrical Characteristics (T_J=25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0V, I_{D} = 250 μ A	650			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 650V, V _{GS} = 0V			10	μA
Gate-Source Leak Current	I _{GSS}	V_{GS} = ± 30 V, V_{DS} = 0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V_{DS} = V_{GS} , I_D = 1mA	3	4	5	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 20A		56	68	mΩ
Input Capacitance	Ciss	N/ 50) () () (4528		
Output Capacitance	Coss	$V_{DS} = 50V, V_{GS} = 0V,$		414		pF
Reverse Transfer Capacitance	C _{RSS}	f = 1MHz		3		
Total Gate Charge	Q _G			94		nC
Gate to Source Charge	Q _{GS}	$V_{GS} = 0$ to 10V, $V_{DS} = 400V$,		25		
Gate to Drain Charge	Q _{GD}	I _D =17.1A		35		
Turn-on Delay Time	T _{D(ON)}			22		
Rise Time	Tr	V _{GS} = 13V, V _{DS} = 400V, I _D =17.1A, R _G = 5.3Ω		11		- ns
Turn-off Delay Time	T _{D(OFF)}			87		
Fall Time	T _f			9		
Drain to Source Diode Forward Voltage	V _{SD}	VGS = 0V		0.88	1.2	V

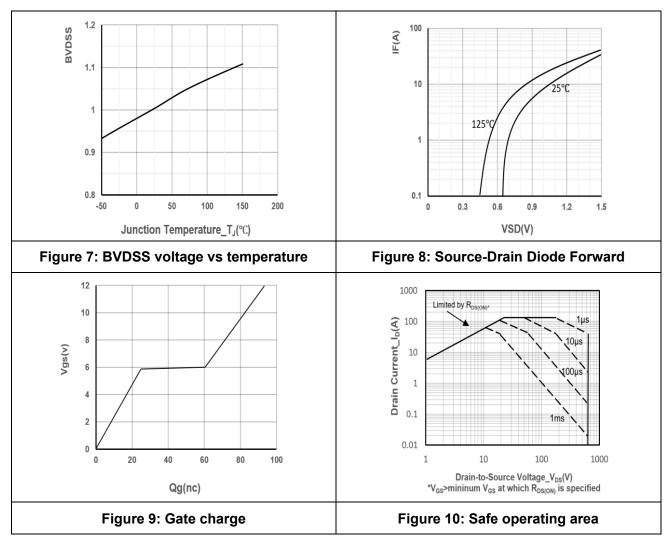


> Typical Performance Characteristics (T_J=25[°]C unless otherwise noted)





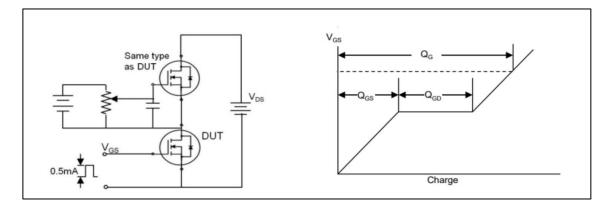
> Typical Performance Characteristics (T_J=25[°]C unless otherwise noted)



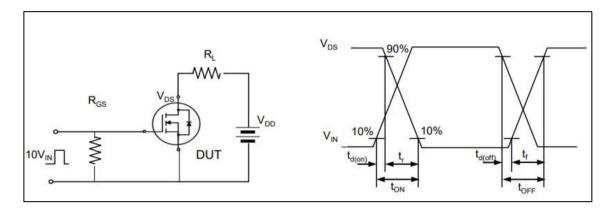


> Test Circuits

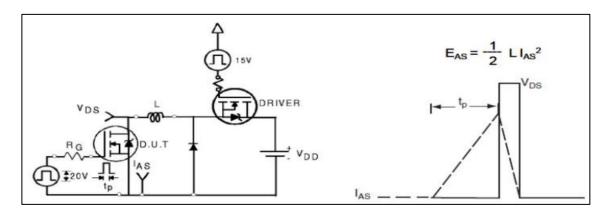
1. Gate charge test circuit & waveform



2. Switching time test circuit & waveform



3. Unclamped Inductive switching test circuit & waveform

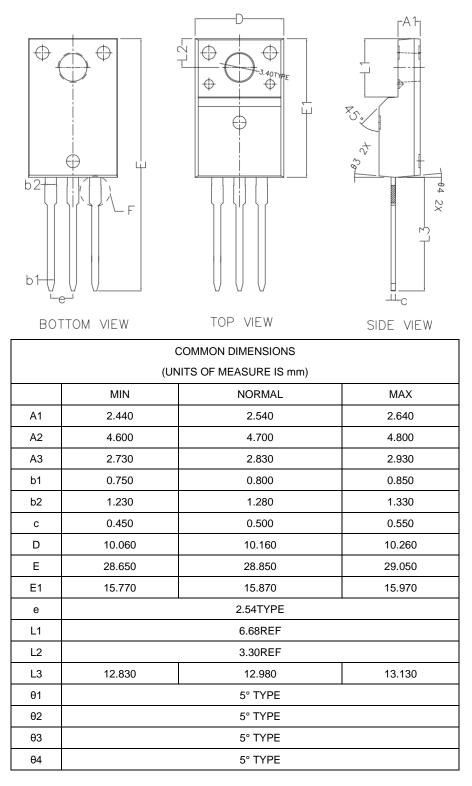






Package Information

TO220F-3L





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